


SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

1.MATERIAL:

HOUSING: PBT, BLACK, UL94V-0
 CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH
 100µ" MINIMUM THICK TIN IN SOLDER AREA.
 15µ" MINIMUM GOLD IN LOCALIZED PLATE AREA.
 ENTIRE CONTACTS PLATED WITH 30µ" MINIMUM THICK NICKEL.
 SHIELDED: 0.25[0.0098] THICK COPPER ZINC ALLOY PLATED WITH
 30µ" MINIMUM THICK NICKEL.

2.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.

3.PART NUMBER: HRJM15-S1488-0-D-F2

				JOINT TECH ELECTRONIC IND. CO., LTD. JOY DAY INDUSTRIAL CO., LTD.	
		UNIT	SCALE	SHEET	TITLE:
		mm[inch]		1 of 1	RJ45, MODULAR JACK, 1X4, W/O LED, 8P, 8C, SHIELDED, THRU-HOLE
		DRAWN BY 董正一		APPROVED BY 謝瑞清	
		2002.02.01		2002.02.01	
		GENERAL TOLERANCE			
		X. X±0.25	ANGLE±		
		X. XX±0.15	▽		
		X. XXX±0.05	⊕		
B0	NEW RELEASE	2005.12.25	DRAW NO. :		
REV.	DESCRIPTION	DATE	HRJM15-S1488-0-D-F2		
					REV. B0